

OBSOLETE - PART DISCONTINUED

Description

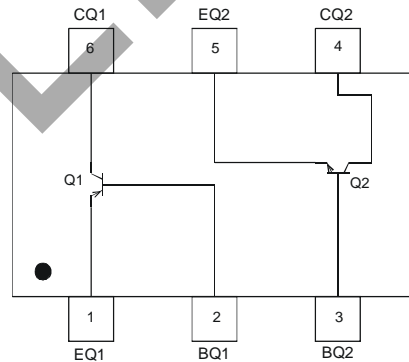
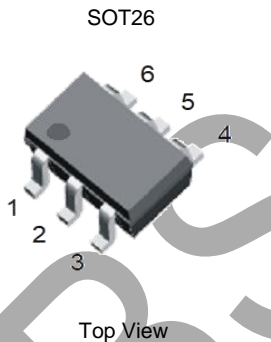
DIODES™ LMN150B01 is best suited for applications where the load needs to be turned on and off using control circuits like micro-controllers, comparators etc., particularly at a point of load. It features a discrete PNP pass transistor with stable $V_{CE(sat)}$ which does not depend on the input voltage and can support maximum continuous current of 150mA up to +125°C (see Fig. 1). It also contains a discrete NPN that can be used as a control. The component devices can be used as a part of a circuit or as standalone discrete devices.

Features

- Epitaxial Planar Die Construction
- Ideally Suited for Automated Assembly Processes
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please [contact us](mailto:contact@diodes.com) or your local Diodes representative. <https://www.diodes.com/quality/product-definitions/>**

Mechanical Data

- Package: SOT26
- Package Material: Molded Plastic. "Green Molding" Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram
- Terminals: Finish - Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 e3
- Weight: 0.016 grams (Approximate)

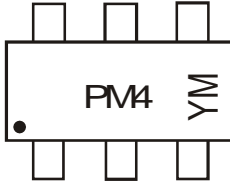


Ordering Information (Note 4)

Part Number	Marking Code	Package	Packing	
			Qty.	Carrier
LBN150B01-7	PM4	SOT26	3000	Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 2. See <https://www.diodes.com/quality/lead-free/> for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <https://www.diodes.com/design/support/packaging/diodes-packaging/>.

Marking Information



PM4 = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: K = 2023)
 M = Month (ex: 9 = September)

Date Code Key

Year	2006	2023	2024	2025	2026	2027	2028	2029	2030	2031	2032
Code	T	K	L	M	N	O	P	R	S	T	U
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings, Total Device (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Output Current	I _{out}	150	mA

Thermal Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	300	mW
Power Derating Factor above +120°C	P _{der}	2.33	mW/°C
Thermal Resistance, Junction to Ambient Air (Note 5) (Equivalent to One Heated Junction of PNP Transistor)	R _{θJA}	417	°C/W
Junction Operation and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

Note: 5. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch; pad layout as shown on Page 9.

Maximum Ratings: Discrete PNP Transistor (Q1) (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CB0}	-40	V
Collector-Emitter Voltage	V _{CE0}	-40	V
Emitter-Base Voltage	V _{EBO}	-6	V
Output Current - Continuous (Note 6)	I _c	-200	mA

Maximum Ratings: Discrete NPN Transistor (Q2) (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Collector-Base Voltage	V _{CB0}	60	V
Collector-Emitter Voltage	V _{CE0}	40	V
Emitter-Base Voltage	V _{EBO}	6	V
Output Current - continuous (Note 6)	I _c	200	mA

Note: 6. Short duration pulse test used to minimize self-heating effect.

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Electrical Characteristics: Discrete PNP Transistor (Q1) (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)					
Collector-Base Breakdown Voltage	V _{CB0}	-40	—	V	I _C = -10μA, I _E = 0
Collector-Emitter Breakdown Voltage	V _{CEO}	-40	—	V	I _C = -1.0mA, I _B = 0
Emitter-Base Breakdown Voltage	V _{EBO}	-6	—	V	I _E = -10μA, I _C = 0
Collector Cutoff Current	I _{CEX}	—	-50	nA	V _{CE} = -30V, V _{EB(off)} = -3.0V
Base Cutoff Current	I _{BL}	—	-50	nA	V _{CE} = -30V, V _{EB(off)} = -3.0V
Collector-Base Cut Off Current	I _{CBO}	—	-50	nA	V _{CB} = -30V, I _E = 0
Collector-Emitter Cut Off Current	I _{CEO}	—	-50	nA	V _{CE} = -30V, I _B = 0
Emitter-Base Cut Off Current	I _{EBO}	—	-50	nA	V _{EB} = -5V, I _C = 0
ON CHARACTERISTICS (Note 6)					
DC Current Gain	h _{FE}	105	—	—	V _{CE} = -1V, I _C = -100μA
		110	—	—	V _{CE} = -1V, I _C = -1mA
		120	—	—	V _{CE} = -1V, I _C = -10mA
		90	—	—	V _{CE} = -1V, I _C = -50mA
		32	—	—	V _{CE} = -1V, I _C = -100mA
		10	—	—	V _{CE} = -1V, I _C = -200mA
Collector-Emitter Saturation Voltage	V _{CE(sat)}	—	-0.08	V	I _C = -10 mA, I _B = -1mA
		—	-0.15		I _C = -50mA, I _B = -5mA
		—	-0.5		I _C = -200mA, I _B = -20mA
Equivalent On-Resistance	R _{CE(sat)}	—	2.5	Ω	I _C = -200mA, I _B = -20mA
Base-Emitter Turn-on Voltage	V _{BE(on)}	—	-0.92	V	V _{CE} = -5V, I _C = -200mA
Base-Emitter Saturation Voltage	V _{BE(sat)}	—	-0.95	V	I _C = -10mA, I _B = -1mA
		—	-1.1		I _C = -50mA, I _B = -5mA
SMALL SIGNAL CHARACTERISTICS					
Output Capacitance	C _{obo}	—	4	pF	V _{CB} = -5.0V, f = 1.0MHz, I _E = 0
Input Capacitance	C _{ibo}	—	8	pF	V _{EB} = -5.0V, f = 1.0MHz, I _C = 0
Input Impedance	h _{iE}	2	12	kΩ	V _{CE} = 1.0V, I _C = 10mA, f = 1.0kHz
Voltage Feedback Ratio	h _{RE}	0.1	10	x 10E-4	
Small Signal Current Gain	h _{FE}	100	400	—	
Output Admittance	h _{oe}	3	60	μS	
Current Gain-Bandwidth Product	f _r	250	—	MHz	
Noise Figure	NF	—	4	dB	V _{CE} = -5V, I _C = -100μA, R _s = 1Ω f = 1kHz
SWITCHING CHARACTERISTICS					
Delay Time	t _d	—	35	ns	V _{CC} = -3.0V, I _C = -10mA
Rise Time	t _r	—	35	ns	V _{BE(off)} = 0.5V, I _{B1} = -1.0mA
Storage Time	t _s	—	225	ns	V _{CC} = -3.0V, I _C = -10mA
Fall Time	t _f	—	75	ns	I _{B1} = I _{B2} = -1.0mA

Note: 6. Short duration pulse test used to minimize self-heating effect.

Electrical Characteristics: Discrete NPN Transistor (Q2) (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 6)					
Collector-Base Breakdown Voltage	V _{CB0}	60	—	V	I _C = 10μA, I _E = 0
Collector-Emitter Breakdown Voltage	V _{CEO}	40	—	V	I _C = 1.0mA, I _B = 0
Emitter-Base Breakdown Voltage	V _{EB0}	6	—	V	I _E = 10μA, I _C = 0
Collector Cutoff Current	I _{CEX}	—	50	nA	V _{CE} = 30V, V _{EB(off)} = 3.0V
Base Cutoff Current	I _{BL}	—	50	nA	V _{CE} = 30V, V _{EB(off)} = 3.0V
Collector-Base Cut Off Current	I _{CB0}	—	50	nA	V _{CB} = 30V, I _E = 0
Collector-Emitter Cut Off Current	I _{CEO}	—	50	nA	V _{CE} = 30V, I _B = 0
Emitter-Base Cut Off Current	I _{EB0}	—	50	nA	V _{EB} = 5V, I _C = 0
ON CHARACTERISTICS (Note 6)					
DC Current Gain	h _{FE}	150	—	—	V _{CE} = 1V, I _C = 100μA
		170	—	—	V _{CE} = 1V, I _C = 1mA
		160	—	—	V _{CE} = 1V, I _C = 10mA
		70	—	—	V _{CE} = 1V, I _C = 50mA
		30	—	—	V _{CE} = 1V, I _C = 100mA
		12	—	—	V _{CE} = 1V, I _C = 200mA
Collector-Emitter Saturation Voltage	V _{CE(sat)}	—	0.08	V	I _C = 10mA, I _B = 1mA
		—	0.16		I _C = 50mA, I _B = 5mA
		—	0.36		I _C = 200mA, I _B = 20mA
Equivalent On-Resistance	R _{CE(sat)}	—	1.8	Ω	I _C = 200mA, I _B = 20mA
Base-Emitter Turn-on Voltage	V _{BE(on)}	—	0.98	V	V _{CE} = 5V, I _C = 200mA
Base-Emitter Saturation Voltage	V _{BE(sat)}	—	0.95	V	I _C = 10mA, I _B = 1mA
		—	1.1		I _C = 50mA, I _B = 5mA
SMALL SIGNAL CHARACTERISTICS					
Output Capacitance	C _{obo}	—	4	pF	V _{CB} = 5.0V, f = 1.0MHz, I _E = 0
Input Capacitance	C _{ibo}	—	8	pF	V _{EB} = 5.0V, f = 1.0MHz, I _C = 0
Input Impedance	h _{iE}	2	12	kΩ	V _{CE} = 1.0V, I _C = 10mA, f = 1.0kHz
Voltage Feedback Ratio	h _{RE}	0.1	10	x 10E-4	
Small Signal Current Gain	h _{FE}	100	400	—	
Output Admittance	h _{oe}	3	60	μS	
Current Gain-Bandwidth Product	f _r	250	—	MHz	
Noise Figure	NF	—	4	dB	V _{CE} = 5V, I _C = 100μA, R _s = 1Ω f = 1kHz
SWITCHING CHARACTERISTICS					
Delay Time	t _d	—	35	ns	V _{CC} = -3.0V, I _C = 10mA,
Rise Time	t _r	—	35	ns	V _{BE(off)} = 0.5V, I _{B1} = 1.0mA

Note: 6. Short duration pulse test used to minimize self-heating effect.

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Typical Characteristics

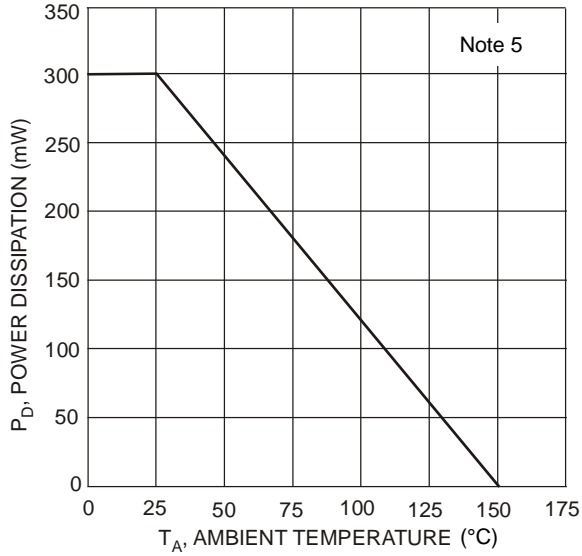


Fig. 1 Max Power Dissipation vs Ambient Temperature

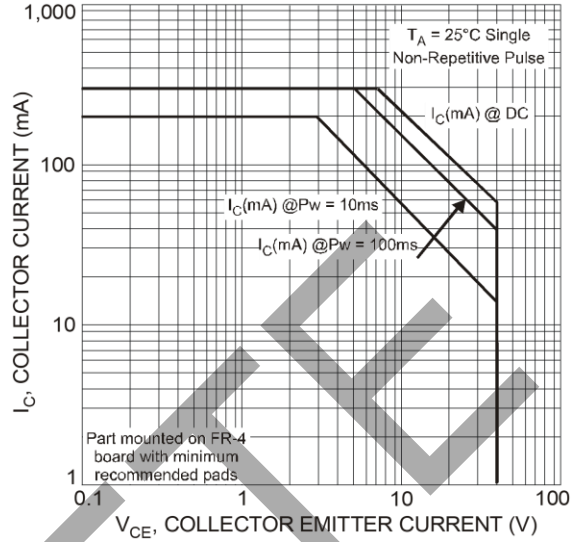


Fig. 2 Safe Operating Area

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Characteristics of NPN Transistor (Q2):

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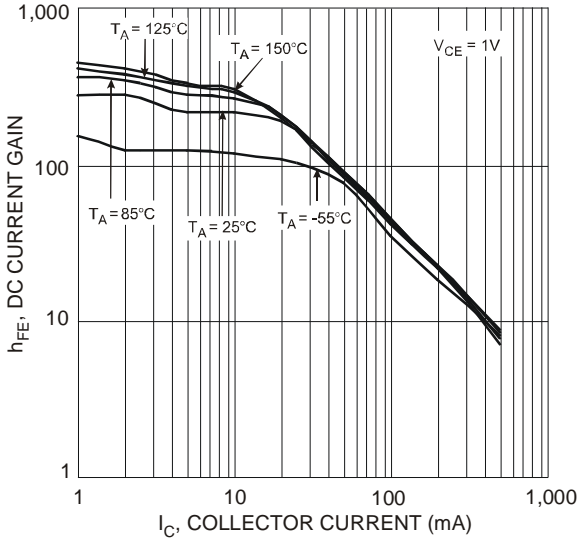


Fig. 3 Typical DC Current Gain vs. Collector Current

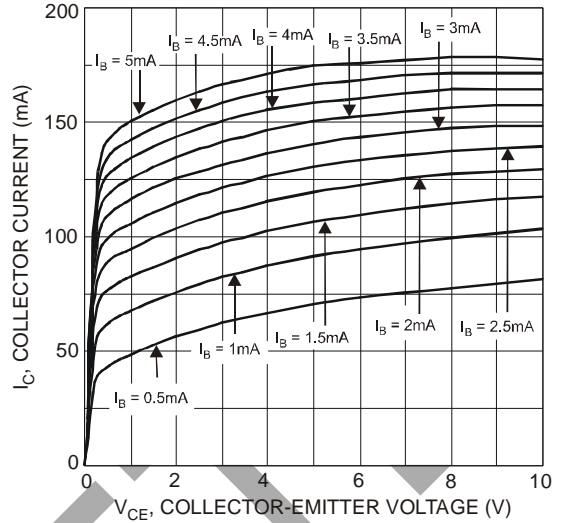


Fig. 4 Collector Current vs. Collector-Emitter Voltage

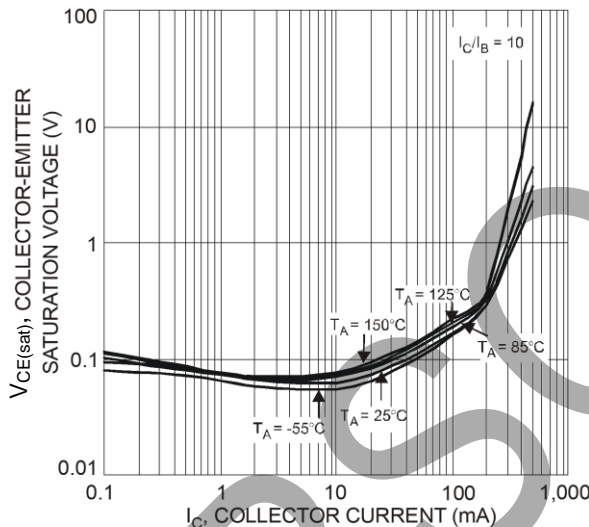


Fig. 5 Collector-Emitter Saturation Voltage vs. Collector Current

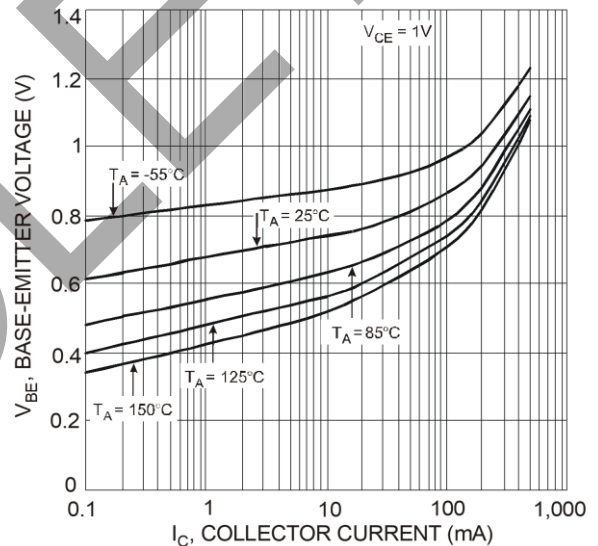


Fig. 6 Base-Emitter Turn-on Voltage vs. Collector Current

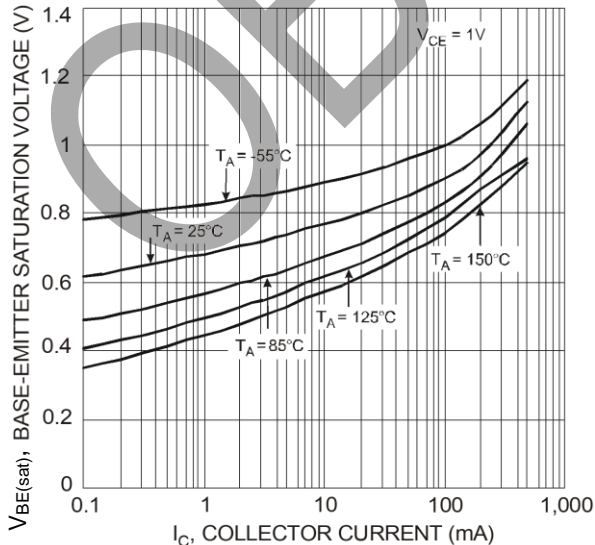


Fig. 7 Base-Emitter Saturation Voltage vs. Collector Current

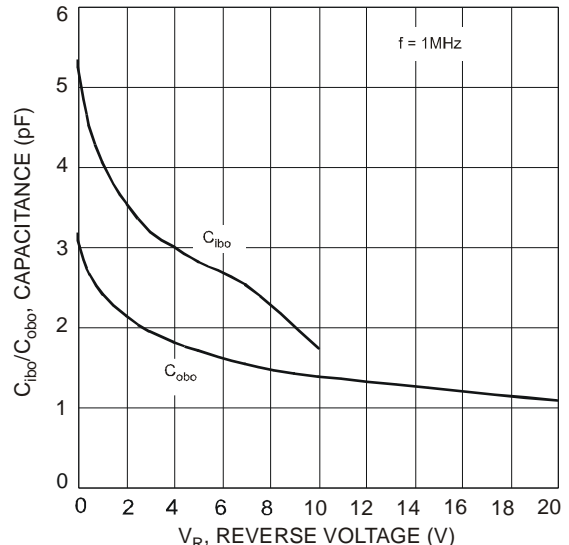


Fig. 8 Typical Capacitance Characteristics

Characteristics of PNP Transistor (Q1):

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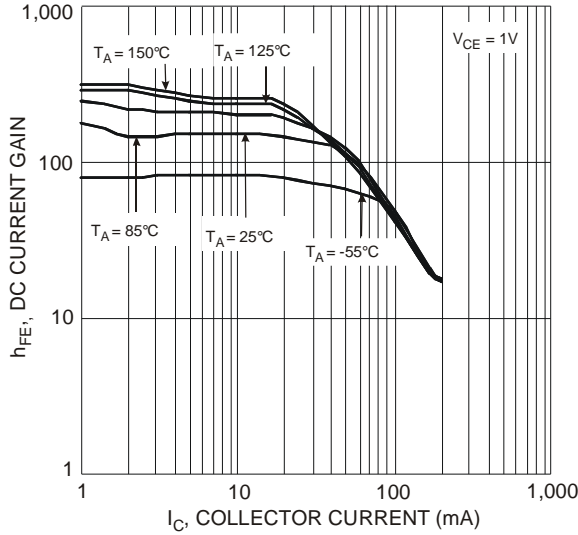


Fig. 9 Typical DC Current Gain vs. Collector Current

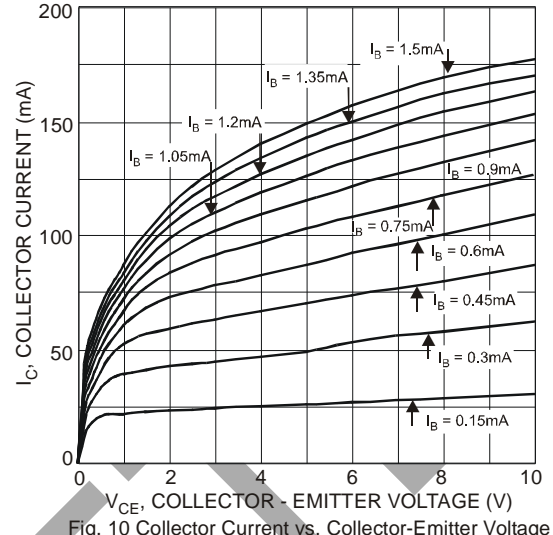


Fig. 10 Collector Current vs. Collector-Emitter Voltage

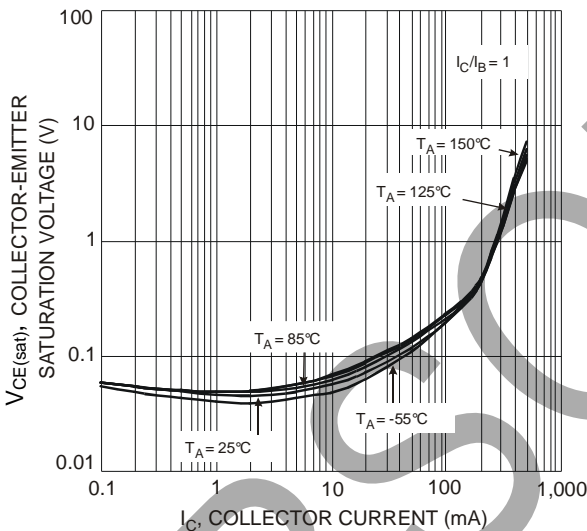


Fig. 11 Collector-Emitter Saturation Voltage vs. Collector Current

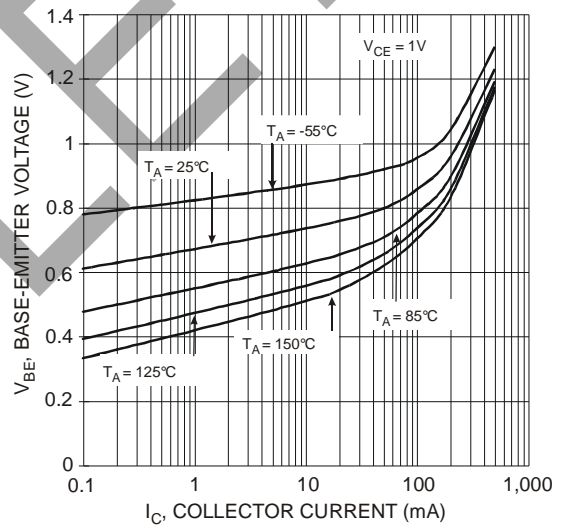


Fig. 12 Base-Emitter Turn-On Voltage vs. Collector Current

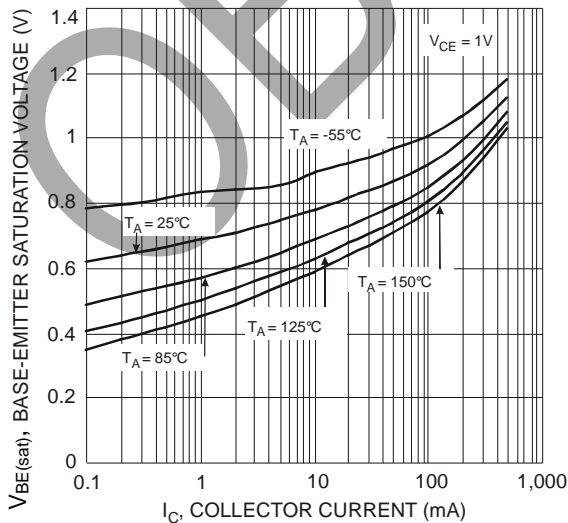


Fig. 13 Base-Emitter Saturation Voltage vs. Collector Current

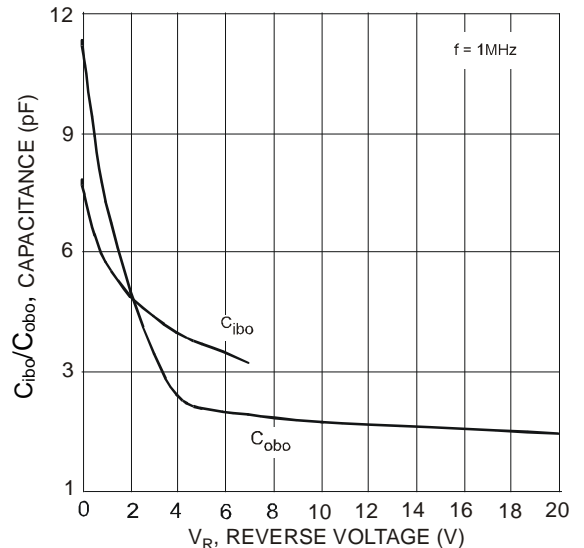
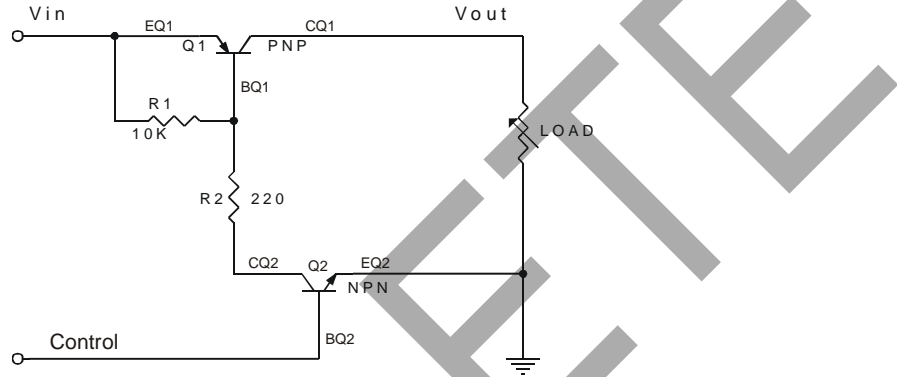


Fig. 14 Typical Capacitance Characteristics

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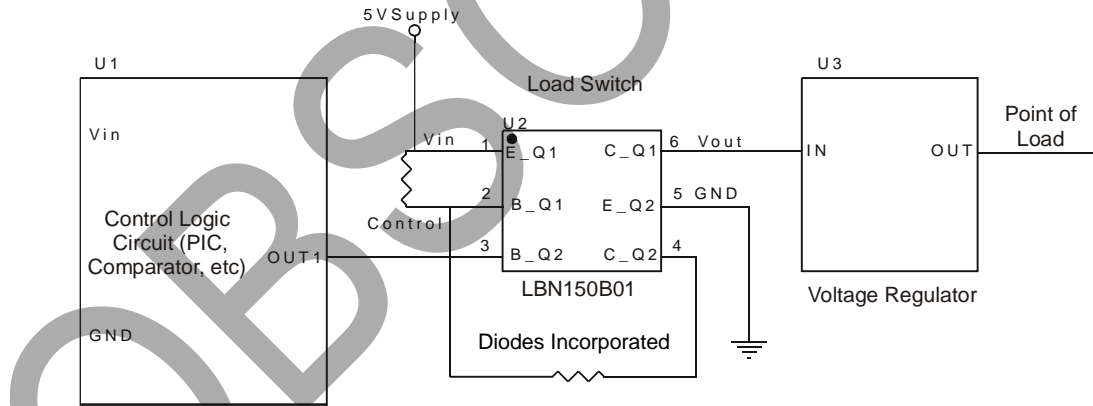
Application Details

PNP Transistor and NPN Transistor integrated as one in LBN150B01 can be used as a discrete entity for general purpose applications or as a part of a circuit to function as a Load Switch. When it is used as the latter as shown in Example Circuit Schematic, various input voltage sources can be used as long as they do not exceed the maximum rating of the device. These devices are designed to deliver continuous output load current up to maximum of 150mA. The use of the NPN as a switch eliminates the need for higher current required to overcome the gate charge in the event an N-MOSFET is used. Care must be taken for higher levels of dissipation while designing for higher load conditions. These devices provide power on demand and also consume less space. It mainly helps in optimizing power usage, thereby conserving battery life in a controlled load system like portable battery powered applications. (Please see Figure below for one example of typical application circuit used in conjunction with a voltage regulator as a part of power management system).



Example Circuit Schematic

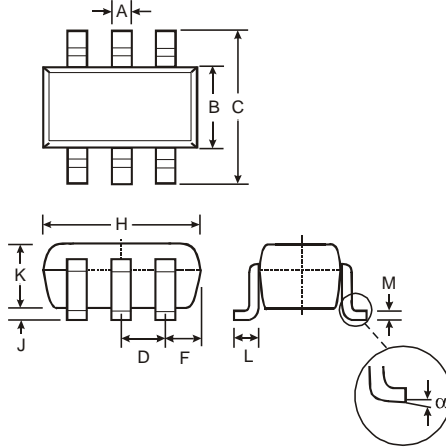
Typical Application Circuit



Package Outline Dimensions

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT26

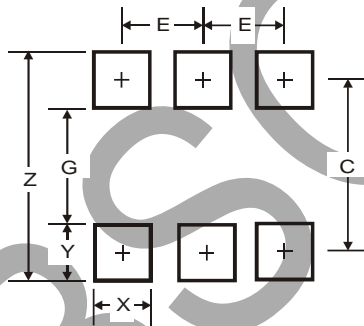


SOT26			
Dim	Min	Max	Typ
A	0.35	0.50	0.38
B	1.50	1.70	1.60
C	2.70	3.00	2.80
D	—	—	0.95
F	—	—	0.55
H	2.90	3.10	3.00
J	0.013	0.10	0.05
K	1.00	1.30	1.10
L	0.35	0.55	0.40
M	0.10	0.20	0.15
α	0°	8°	—
All Dimensions in mm			

Suggested Pad Layout

Please see <http://www.diodes.com/package-outlines.html> for the latest version.

SOT26



Dimensions	Value (in mm)
Z	3.20
G	1.60
X	0.55
Y	0.80
C	2.40
E	0.95

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